

## **MOSFET**

### OptiMOS™ 3 Power-MOSFET, 30 V

#### **Features**

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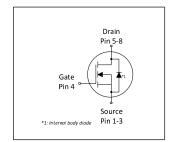
- Features
  Fast switching MOSFET for SMPS
  Optimized technology for DC/DC converters
  Qualified according to JEDEC<sup>1)</sup> for target applications
  N-channel; Logic level
  Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  Superior thermal resistance
  Avalanche rated
  Ph free plating: PoHS compliant

- Pb-free plating; RoHS compliant
  Halogen-free according to IEC61249-2-21



Parameter	Value	Unit
V <sub>DS</sub>	30	٧
R <sub>DS(on),max</sub>	3.4	mΩ
I <sub>D</sub>	109	A











Type / Ordering Code	Package	Marking	Related Links
BSC034N03LS G	PG-TDSON-8	034N03LS	-

# OptiMOS™ 3 Power-MOSFET, 30 V BSC034N03LS G



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## OptiMOS™ 3 Power-MOSFET, 30 V BSC034N03LS G



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Dougueston	Cumb al	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	l <sub>D</sub>	- - - - -	- - - -	109 69 89 56 22	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50K/W <sup>2</sup> )
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	436	Α	T <sub>C</sub> =25 °C
Avalanche current, single pulse4)	I <sub>AS</sub>	-	-	50	Α	T <sub>C</sub> =25 °C
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	55	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	63 2.5	W	$T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 K/W <sup>2)</sup>
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### 2 Thermal characteristics

Table 3 **Thermal characteristics** 

Parameter	Symbol	Values			Unit	Note / Test Condition
raiameter	Symbol	Min.	Тур.	Max.	Ullit	Note / Test Condition
Thermal resistance, junction - case, bottom	$R_{thJC}$	_	-	2.0	K/W	-
Thermal resistance, junction - case, top	R <sub>thJC</sub>	-	-	20	K/W	-
Device on PCB, 6 cm² cooling area²)	R <sub>thJA</sub>	_	_	50	K/W	-

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm2 (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

<sup>&</sup>lt;sup>3)</sup> See Diagram 3 for more detailed information<sup>4)</sup> See Diagram 13 for more detailed information

## OptiMOS™ 3 Power-MOSFET, 30 V BSC034N03LS G



# 3 Electrical characteristics at $T_j$ =25 °C, unless otherwise specified

Table 4 **Static characteristics** 

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	30	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.0	-	2.2	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1.0 100	μA	V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =30 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	4.1 2.8	5.1 3.4	mΩ	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =30 A V <sub>GS</sub> =10 V, I <sub>D</sub> =30 A
Gate resistance	R <sub>G</sub>	0.7	1.5	1.8	Ω	-
Transconductance	$g_{fs}$	45	90	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =30 A

 Table 5
 Dynamic characteristics

Darameter	Coursels al	Values			11	Nata / Tank Oam did an
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	3200	4300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1000	1300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Reverse transfer capacitance	C <sub>rss</sub>	-	62	-	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =15 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{ m d(on)}$	-	6.9	_	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	4.8	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	28	-	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	4.6	_	ns	$V_{\rm DD}$ =15 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =30 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Parameter			Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	$Q_{gs}$	-	9.0	12.0	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	4.8	6.4	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate to drain charge	$Q_{ m gd}$	-	4.3	7.2	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Switching charge	Q <sub>sw</sub>	-	8.5	12.8	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	18.8	25	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate plateau voltage	V <sub>plateau</sub>	-	3.0	-	V	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 4.5 V
Gate charge total	Qg	-	39	52	nC	$V_{\rm DD}$ =15 V, $I_{\rm D}$ =30 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	16.3	22	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 4.5 V
Output charge	Q <sub>oss</sub>	-	27	36	nC	V <sub>DD</sub> =15 V, V <sub>GS</sub> =0 V

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test <sup>2)</sup> See figure 16 for gate charge parameter definition. Defined by design, not subject to production test

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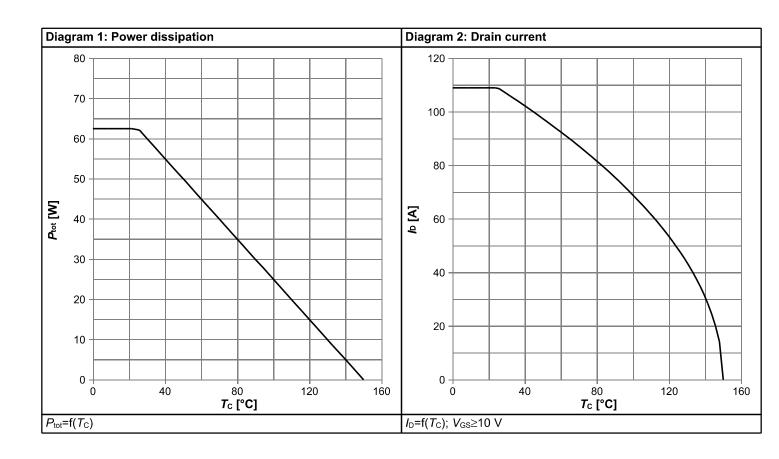
### Table 7 Reverse diode

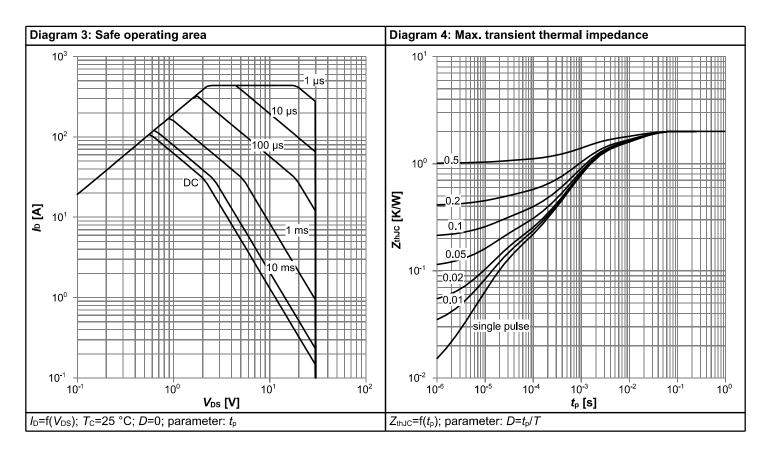
Davameter	Cymbol	Values			11	Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	57	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	436	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.83	1.1	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =30 A, T <sub>j</sub> =25 °C	
Reverse recovery charge <sup>1)</sup>	Qrr	-	-	10	nC	V <sub>R</sub> =15 V, I <sub>F</sub> =I <sub>S</sub> , di <sub>F</sub> /dt=400 A/μs	

5

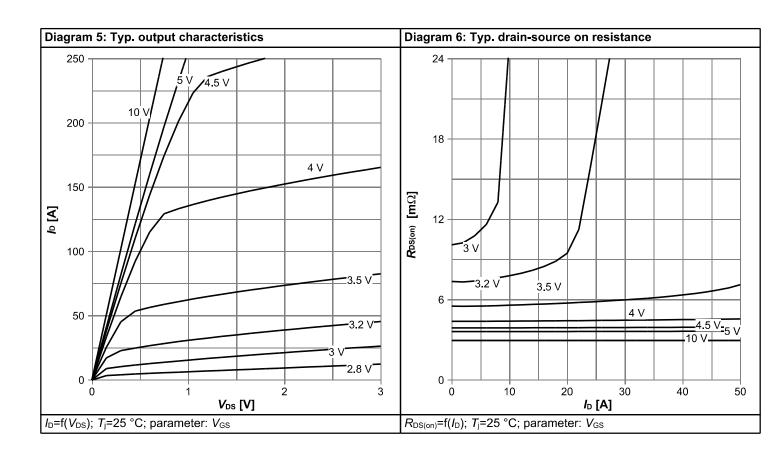


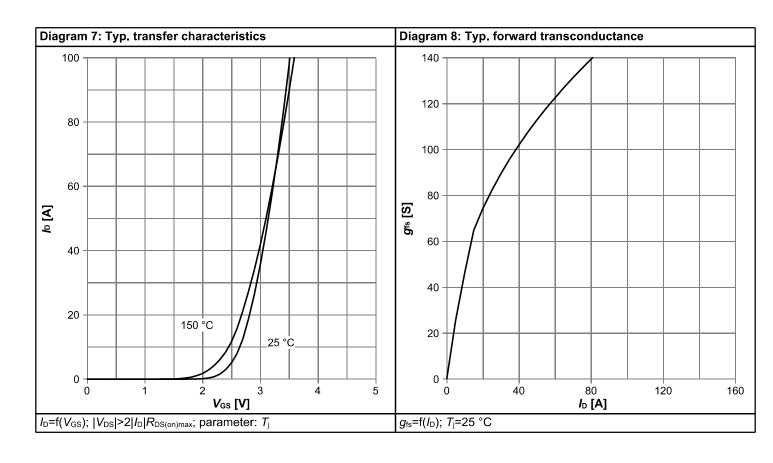
## 4 Electrical characteristics diagrams



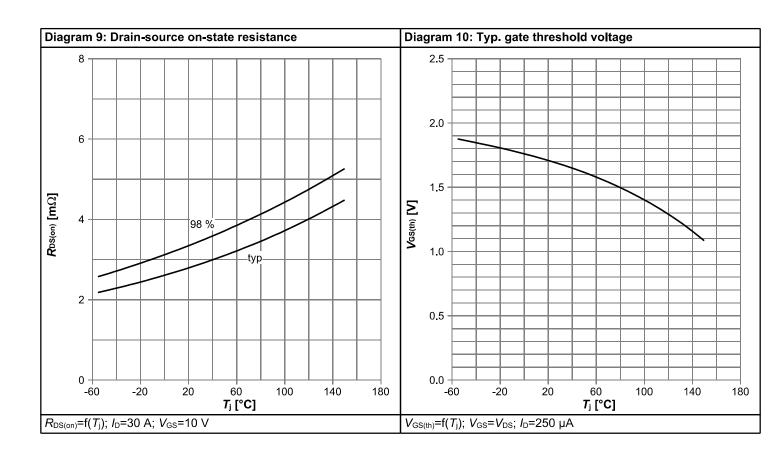


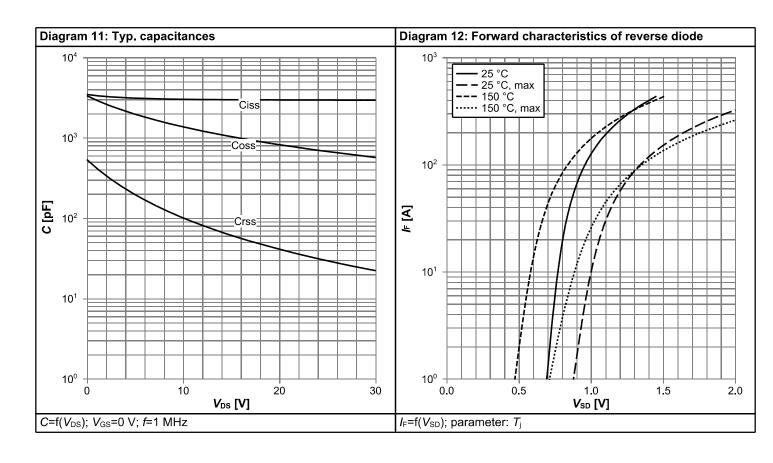




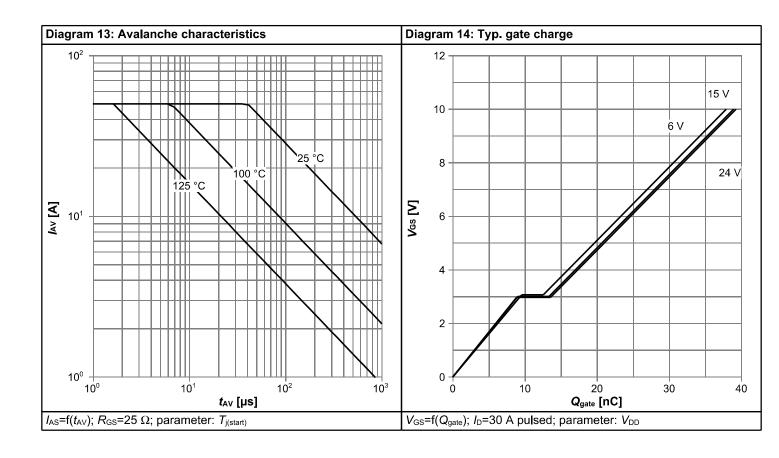


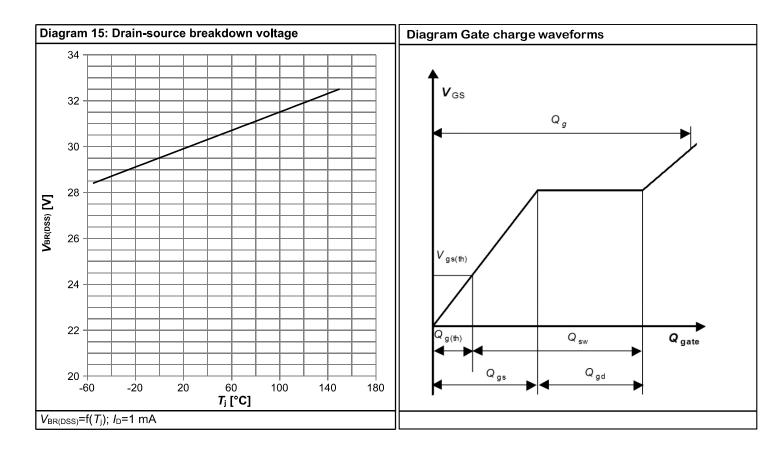






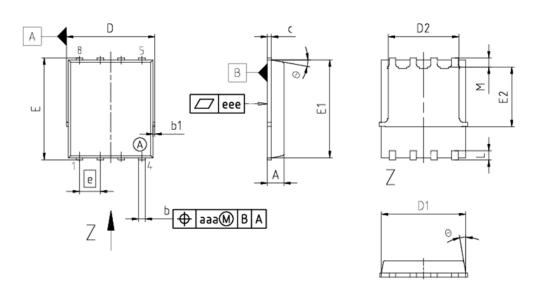








# 5 Package Outlines



DIM	MILLIM	ETERS			
DIM	MIN	MAX			
Α	0.90	1.10			
b	0.31	0.54			
b1	0.02	0.22			
С	0.15	0.35			
D	5.15	5.49			
D1	4.95	5.35			
D2	3.70	4.40			
E	5.95	6.35			
E1	5.70 6.10				
E2	3.40 3.80				
e	1.27				
N	8				
L	0.45 0.71				
M	0.45 0.75				
Θ	8.5°	12°			
aaa	0.25				
eee	0.08				

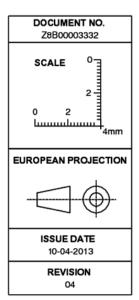


Figure 1 Outline PG-TDSON-8, dimensions in mm



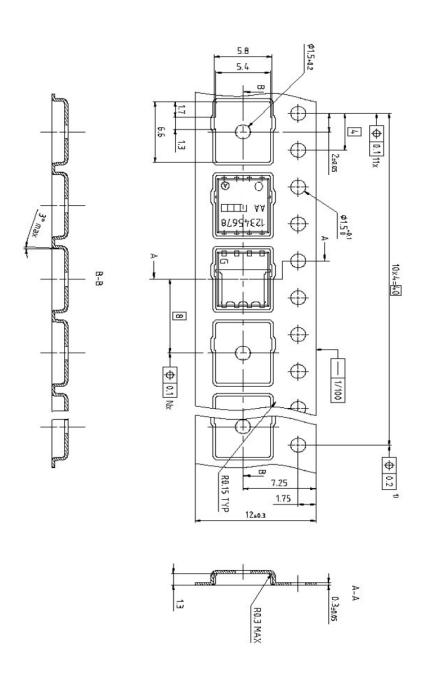


Figure 2 Outline Tape (PG-TDSON-8), dimensions in mm

# OptiMOS™ 3 Power-MOSFET, 30 V BSC034N03LS G



### **Revision History**

BSC034N03LS G

Revision: 2021-06-09, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-06-09	Update current rating, footnotes, Ptot and addition Vsd max

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